

## EXHIBIT B

**Paul Rauch**

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**From:** Jian-Ku Shang [jkshang@uiuc.edu]  
**Sent:** [REDACTED]  
**To:** Keyes, W. John; Rauch, Paul  
**Subject:** Our reference TF 03063 (your ref. 09800240-0071)



TION-PA.doc (1 MB)

Dear John and Paul:

Attached please find a word document providing the details of our processes and materials for the application referenced above. If you need further information or have questions, please contact me directly.

Jian-Ku Shang

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